

## LS5911 MONOLITHIC DUAL N-CHANNEL JFET



## Linear Systems replaces discontinued Siliconix & National 2N5911

The LS5911 are monolithic dual JFETs. The monolithic dual chip design reduces parasitics and gives better performance at very high frequencies while ensuring extremely tight matching. These devices are an excellent choice for use as wideband differential amplifiers in demanding test and measurement applications. The LS5911 is a direct replacement for discontinued Siliconix and National 2N5911.

The 8 Pin P-DIP provides ease of manufacturing, and the symmetrical pinout prevents improper orientation. (See Packaging Information).

## LS5911 Applications:

- Wideband Differential Amps
- High-Speed,Temp-Compensated Single-Ended Input Amps
- High-Speed Comparators
- Impedance Converters and vibrations detectors.

FEATURES			
Improved Direct Replacement for SILICONIX &	& NATIONAL 2N5911		
LOW NOISE (10KHz)	e <sub>n</sub> ~ 4nV/√Hz		
HIGH TRANSCONDUCTANCE (100MHz)	g <sub>fs</sub> ≥ 4000μS		
ABSOLUTE MAXIMUM RATINGS <sup>1</sup>			
@ 25°C (unless otherwise noted)			
Maximum Tomporatures			
Maximum Temperatures			
Storage Temperature	-65°C to +150°C		
Operating Junction Temperature	-55°C to +135°C		
Maximum Power Dissipation			
Continuous Power Dissipation (Total)	500mW		
Maximum Currents			
Gate Current	50mA		
Maximum Voltages			
Gate to Drain	-25V		
Gate to Source	-25V		

MATCHING CHARACTERISTICS @ 25°C (unless otherwise stated)

SYMBOL CHARACTERISTIC		MIN	TYP	MAX	UNITS	CONDITIONS
V <sub>GS1</sub> - V <sub>GS2</sub>   Differential Gate to Source	Differential Gate to Source Cutoff Voltage			10	mV	$V_{DG} = 10V, I_D = 5mA$
$\Delta  V_{GS1} - V_{GS2}  / \Delta T$ Differential Gate to Source	e Cutoff			20	μV/°C	$V_{DG} = 10V, I_{D} = 5mA$
Voltage Change with Tem	perature					$T_A = -55$ °C to +125°C
I <sub>DSS1</sub> / I <sub>DSS2</sub> Gate to Source Saturation	Current Ratio	<b>0</b> .95		_1	%	$V_{DS} = 10V, V_{GS} = 0V$
I <sub>G1</sub> - I <sub>G2</sub>   Differential Gate Current				20	nA	$V_{DG} = 10V, I_D = 5mA$ $T_A = +125^{\circ}C$
g <sub>fs1</sub> / g <sub>fs2</sub> Forward Transconductand	e Ratio <sup>2</sup>	0.95		1	%	$V_{DS} = 10V, I_{D} = 5mA, f = 1kHz$
CMRR Common Mode Rejection	Ratio		85		dB	$V_{DG} = 5V \text{ to } 10V, I_D = 5\text{mA}$

ELECTRICAL CHARACTERISTICS @ 25°C (unless otherwise noted)

SYMBOL	CHARACTERISTICS	MIN.	TYP.	MAX.	UNITS	CONDITIONS
$BV_GSS$	Gate to Source Breakdown Voltage	-25				$I_{G} = -1\mu A, V_{DS} = 0V$
$V_{GS(off)}$	Gate to Source Cutoff Voltage	-1		-5	V	$V_{DS} = 10V, I_{D} = 1nA$
$V_{GS(F)}$	Gate to Source Forward Voltage		0.7			$I_G = 1mA, V_{DS} = 0V$
$V_{GS}$	Gate to Source Voltage	-0.3		-4		$V_{DG} = 10V, I_{G} = 5mA$
I <sub>DSS</sub>	Gate to Source Saturation Current <sup>3</sup>	7		40	mA	$V_{DS} = 10V, V_{GS} = 0V$
I <sub>GSS</sub>	Gate Leakage Current <sup>3</sup>		-1	-50		$V_{GS} = -15V, V_{DS} = 0V$
I <sub>G</sub>	Gate Operating Current		-1	-50	pА	$V_{DG} = 10V$ , $I_D = 5mA$
<b>g</b> fs	Forward Transconductance	4000		10000		
		4000		10000	μS	$V_{DG} = 10V, I_{D} = 5mA$
g <sub>os</sub>	Output Conductance			100		
				150		
C <sub>ISS</sub>	Input Capacitance			5	pF	$V_{DG} = 10V, I_D = 5mA, f = 1MHz$
$C_{RSS}$	Reverse Transfer Capacitance			1.2		
NF	Noise Figure			1	dB	$V_{DG} = 10V$ , $I_D = 5mA$ , $f = 10kHz$ , $R_G = 100K\Omega$
e <sub>n</sub>	Equivalent Input Noise Voltage		7	20	nV/√Hz	$V_{DG} = 10V$ , $I_D = 5mA$ , $f = 100Hz$
			4	10	1	$V_{DG} = 10V$ , $I_D = 5mA$ , $f = 10kHz$

Notes: 1. Absolute Maximum ratings are limiting values above which serviceability may be impaired 2. Pulse Test: PW ≤ 300µs Duty Cycle ≤ 3%

3. Assumes smaller value in numerator



Please contact Micross for full package and die dimensions:

Email: <a href="mailto:chipcomponents@micross.com">chipcomponents@micross.com</a> Web: <a href="mailto:www.micross.com/distribution.aspx">www.micross.com/distribution.aspx</a> Available Packages:

LS5911 in PDIP LS5911 available as bare die



